



RS821S, RS822S
RS821, RS822, RS824

14MHz, Rail-to-Rail I/O CMOS Operational Amplifier

FEATURES

- **HIGH GAIN BANDWIDTH:14MHz**
- **RAIL-TO-RAIL INPUT AND OUTPUT**
0.6mV Typical Vos
- **INPUT VOLTAGE RANGE: -0.1V to +5.6V**
with Vs = 5.5V
- **SUPPLY RANGE: +2.5V to +5.5V**
- **SHUTDOWN: RS821S/RS822S**
- **SPECIFIED UP TO +125°C**
- **MicroSIZE PACKAGES: SOT23-5, SOT23-6**

APPLICATIONS

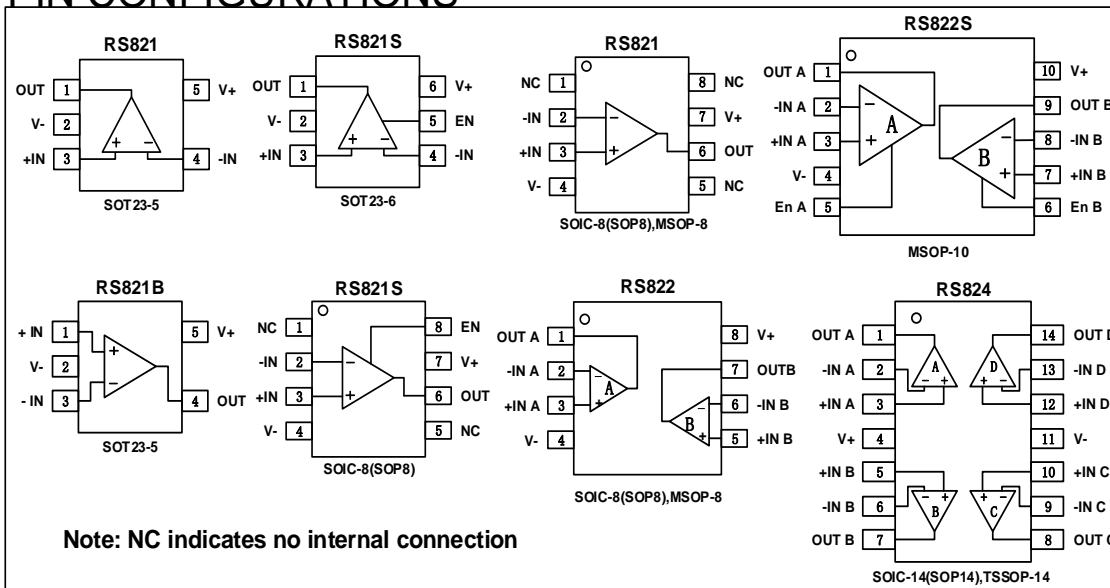
- **SENSORS**
- **PHOTODIODE AMPLIFICATION**
- **ACTIVE FILTERS**
- **TEST EQUIPMENT**
- **DRIVING A/D CONVERTERS**

DESCRIPTION

The RS82X families of products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (14MHz) and slew rate of 10V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS821S, RS822S include a shutdown mode. Under logic control, the amplifiers can be switched from normal operation to a standby current that is less than 1uA. The RS82X families of operational amplifiers are specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.5V to 5.5V.

PIN CONFIGURATIONS





ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage, V+ to V-	7.0V
Input Terminals, Voltage ⁽²⁾	- 0.5 to (V+) + 0.5V
Current ⁽²⁾	±10mA
Storage Temperature	-65°C to +150°C
Operating Temperature	-40°C to +125°C
Junction Temperature	150°C
Package Thermal Resistance @ T _A = +25°C	
SOT23-5, SOT23-6	200°C/W
MSOP-10, SOIC-8	150°C/W
SOIC-14, TSSOP-14	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
HBM	5000V
MM	400V



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	PACKAGE OPTION
RS821	RS821XK	-40°C~125°C	SOIC-8(SOP8)	RS821	Tape and Reel,2500
	RS821XF	-40°C~125°C	SOT23-5	821	Tape and Reel,3000
	RS821BXF	-40°C~125°C	SOT23-5	821B	Tape and Reel,3000
	RS821XM	-40°C~125°C	MSOP-8	RS821	Tape and Reel,3000
RS821S	RS821SXK	-40°C~125°C	SOIC-8(SOP8)	RS821S	Tape and Reel,2500
	RS821SXH	-40°C~125°C	SOT23-6	821S	Tape and Reel,3000
RS822	RS822XK	-40°C~125°C	SOIC-8(SOP8)	RS822	Tape and Reel,2500
	RS822XM	-40°C~125°C	MSOP-8	RS822	Tape and Reel,3000
RS822S	RS822SXN	-40°C~125°C	MSOP-10	RS822S	Tape and Reel,3000
RS824	RS824XP	-40°C~125°C	SOIC-14(SOP14)	RS824	Tape and Reel,2500
	RS824XQ	-40°C~125°C	TSSOP-14	RS824	Tape and Reel,3000



RS821S, RS822S RS821, RS822, RS824

ELECTRICAL CHARACTERISTICS

(At $T_A = +25^\circ\text{C}$, $V_S=5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$, unless otherwise noted.)

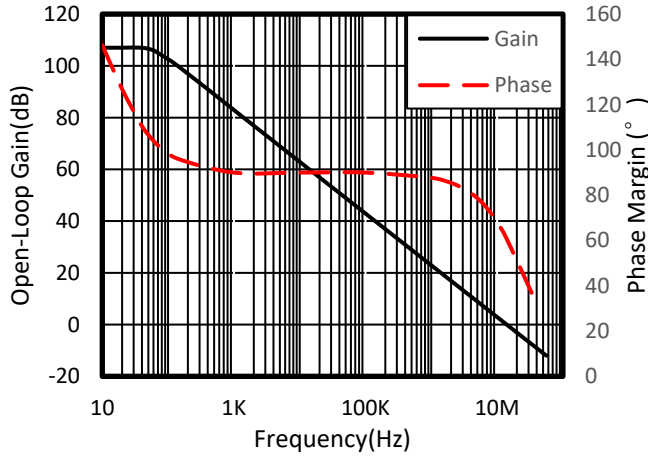
PARAMETER		CONDITIONS	T_J	RS821S, RS822S, RS821, RS822, RS824			UNIT
				MIN	TYP	MAX	
POWER SUPPLY							
V_S	Operating Voltage Range		25°C	2.5		5.5	V
I_Q	Quiescent Current/Amplifier		25°C		1.9	2.5	mA
PSRR	Power-Supply Rejection Ratio	$V_S=2.5\text{V to }5.5\text{V},$ $V_{cm}=(V_-)+0.5\text{V}$	25°C	75	88		dB
			$-40^\circ\text{C to }125^\circ\text{C}$	65			
INPUT							
V_{os}	Input Offset Voltage		25°C		0.6	2.5	mV
$V_{os\ TC}$	Input Offset Voltage Average Drift	$-40^\circ\text{C to }125^\circ\text{C}$			1.6		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current		25°C		1	10	pA
I_{os}	Input Offset Current		25°C		1	10	pA
V_{cm}	Common-Mode Voltage Range	$V_S= 5.5\text{V}$	25°C	-0.1		5.6	V
CMRR	Common-Mode Rejection Ratio	$V_S= 5.5\text{V}, V_{cm}$ $=-0.1\text{V to }4\text{V}$	25°C	75	88		dB
			$-40^\circ\text{C to }125^\circ\text{C}$	67			
			25°C	61	75		
			$-40^\circ\text{C to }125^\circ\text{C}$	58			
OUTPUT							
AOL	Open-Loop Voltage Gain	$R_L=2\text{K}\Omega, V_o=$ $0.15\text{V to }4.85\text{V}$	25°C	91	100		dB
			$-40^\circ\text{C to }125^\circ\text{C}$	78			
			25°C	89	98		
			$-40^\circ\text{C to }125^\circ\text{C}$	75			
	Output Swing From Rail	$R_L=2\text{K}\Omega$ $R_L=10\text{K}\Omega$	25°C		20		mV
					7		
I_{out}	Output Short-Circuit Current		25°C		110		mA
FREQUENCY RESPONSE							
SR	Slew Rate		25°C		10		V/us
GBP	Gain-Bandwidth Product		25°C		14		MHz
PM	Phase Margin		25°C		58		$^\circ$
t_s	Setting Time,0.1%				0.2		us
	Overload Recovery Time	$V_{IN}\cdot\text{Gain} \geq V_S$			0.3		us
NOISE							
e_n	Input Voltage Noise Density		$f = 1\text{KHz}$	25°C		8.5	nV/ $\sqrt{\text{Hz}}$
			$f = 10\text{KHz}$	25°C		5.5	nV/ $\sqrt{\text{Hz}}$
ENABLE/SHUTDOWN(RS821S,RS822S)							
$I_{Q(OFF)}$	Supply Current in Shutdown		25°C		<1		μA
t_{OFF}			25°C		3		us
t_{ON}			25°C		20		us
V_L	Shut Down		25°C	V_-		$(V_-)+0.8$	V
V_H	Amplifier Is Active		25°C	$(V_-)+2$		V_+	V



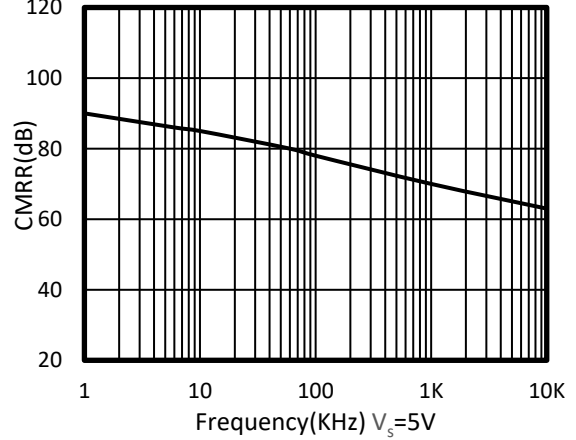
TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

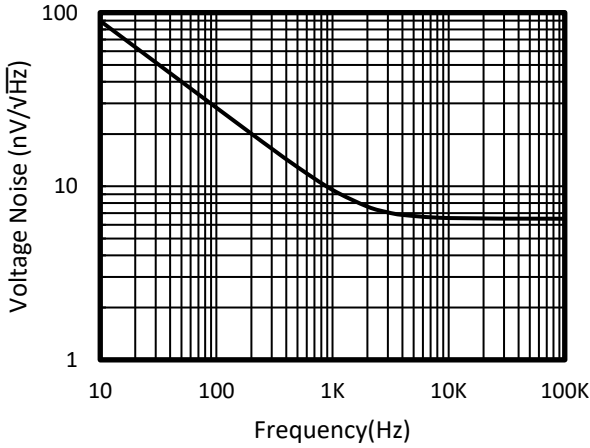
OPEN-LOOP GAIN AND PHASE vs FREQUENCY



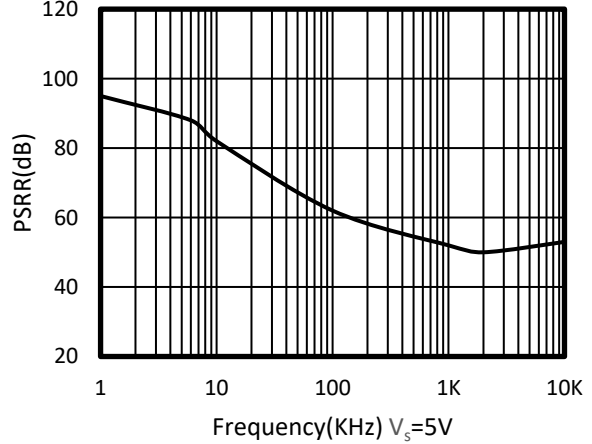
COMMON-MODE REJECTION RATIO vs FREQUENCY



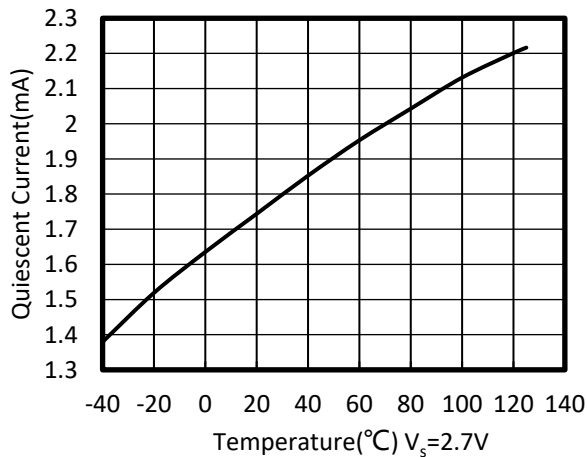
INPUT VOLTAGE NOISE SPECTRAL DENSITY vs FREQUENCY



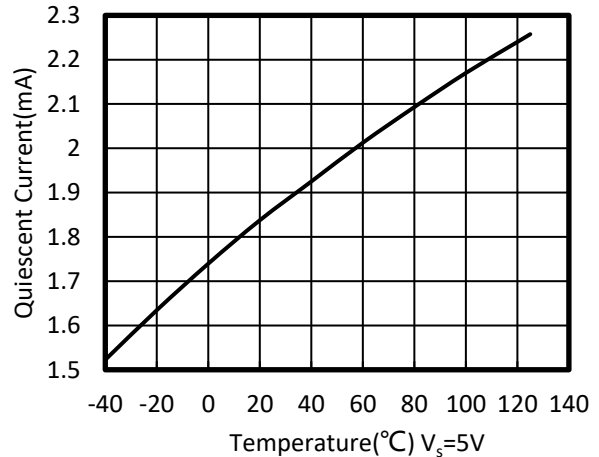
POWER-SUPPLY REJECTION RATIO vs FREQUENCY



QUIESCENT CURRENT vs TEMPERATURE



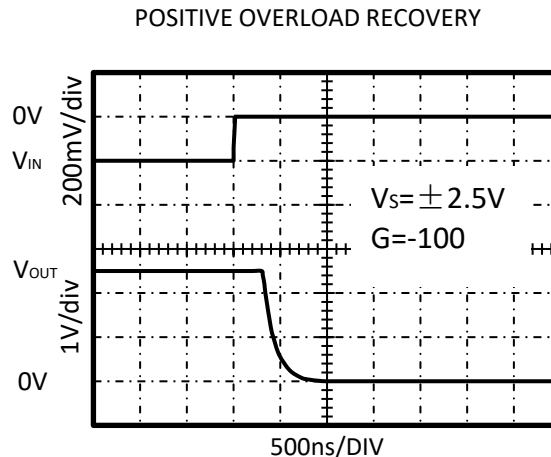
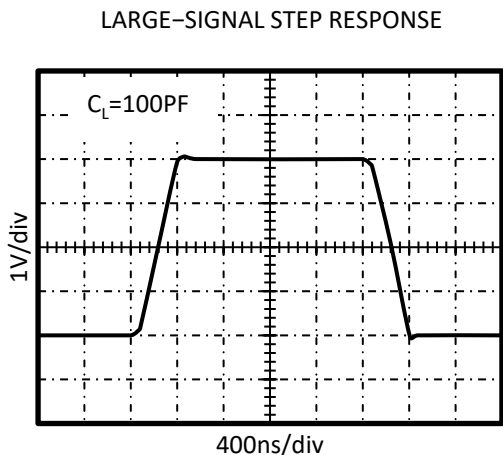
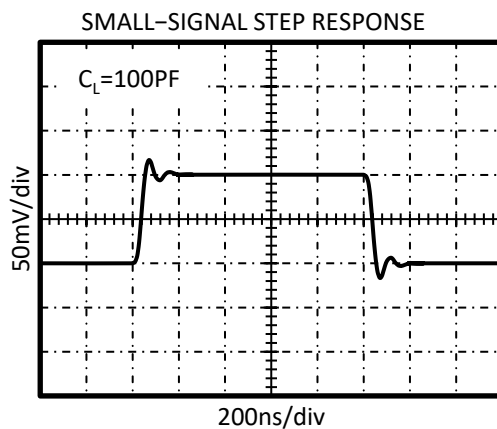
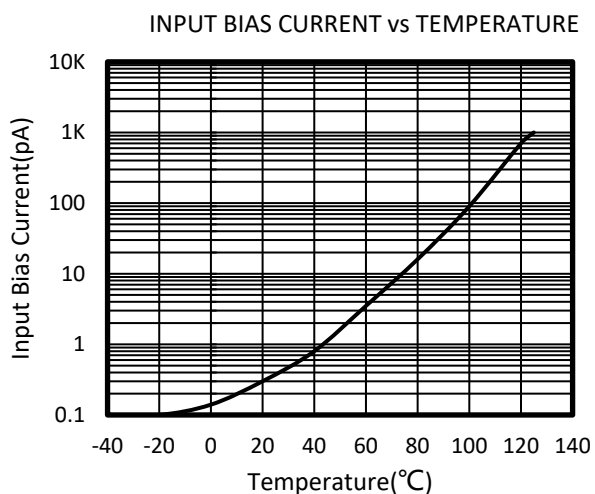
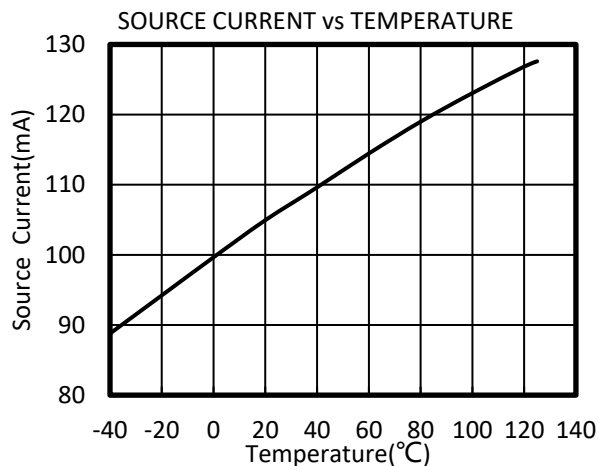
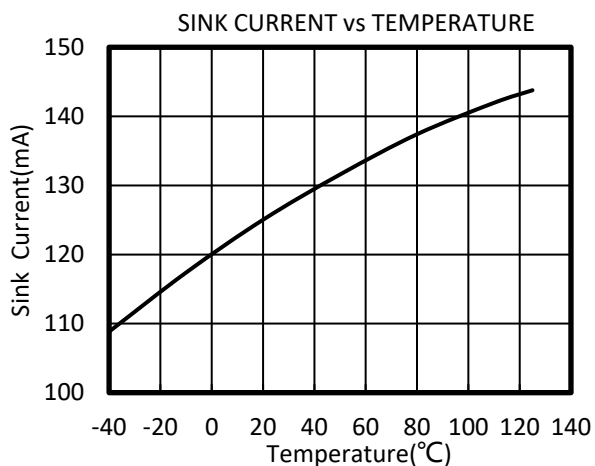
QUIESCENT CURRENT vs TEMPERATURE





TYPICAL CHARACTERISTICS

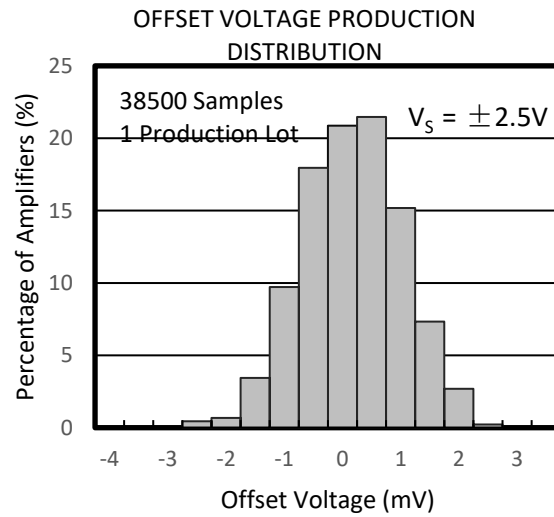
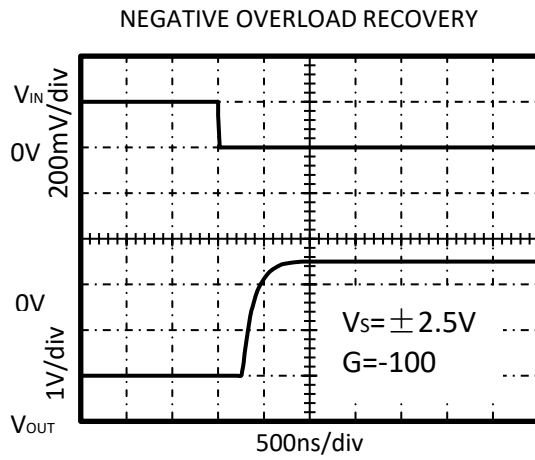
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TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.



APPLICATION NOTES

The RS821, RS822, RS824, RS821S, RS822S are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.5V to 5.5V ($\pm 1.25V$ to $\pm 2.75V$). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier.

Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications.

Good layout practice mandates use of a 0.1 μF capacitor place closely across the supply pins.

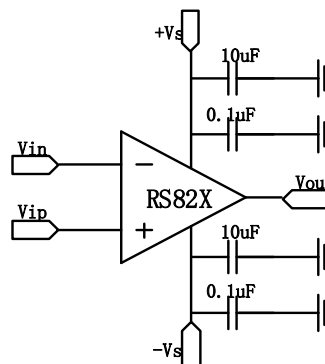


Figure1. Amplifier with Bypass Capacitors

RS821S/RS822S ENABLE FUNCTION

The RS821S/RS822S includes a shutdown mode. Under logic control, the amplifiers can be switched from normal mode to a standby current of 1 μA . When the Enable pin is connected to high, the amplifier is active. Connecting Enable low disables the amplifier, and places the amplifier, and place the output in a high-impedance state.

LAYOUT GUIDELINS

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1 μF capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

INSTRUMENTATION AMPLIFIER

In the three-op amp, instrumentation amplifier configuration shown in Figure2,

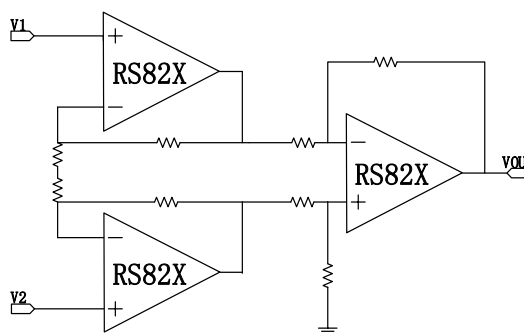
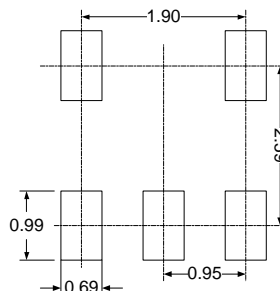
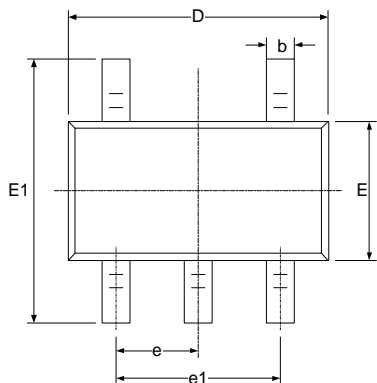


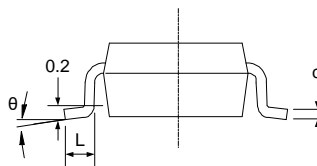
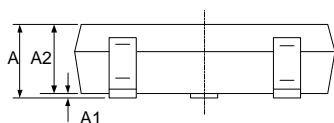
Figure2. Amplifier instrumentation amplifier

PACKAGE OUTLINE DIMENSIONS

SOT23-5

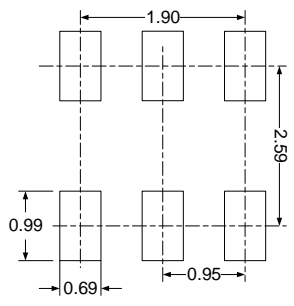
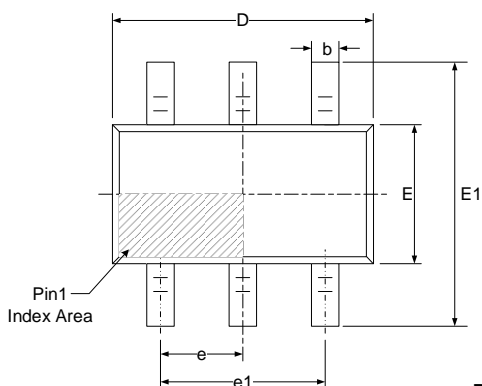


RECOMMENDED LAND PATTERN (Unit: mm)

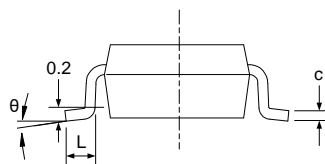
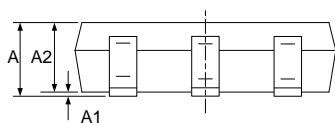


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOT23-6

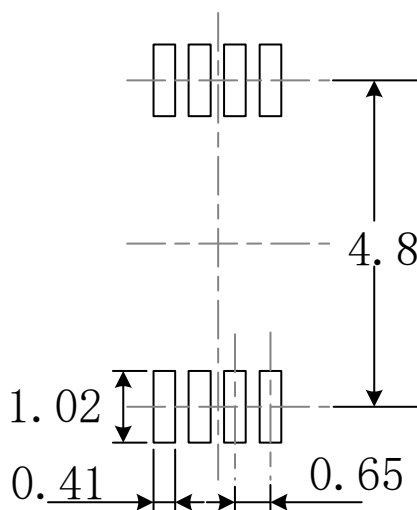
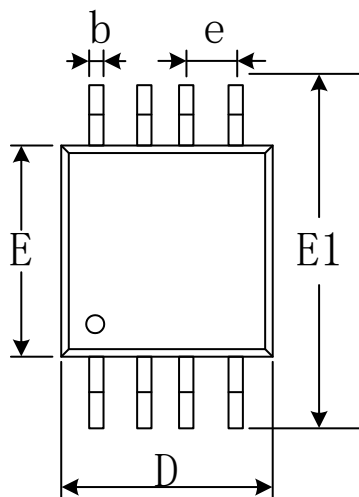


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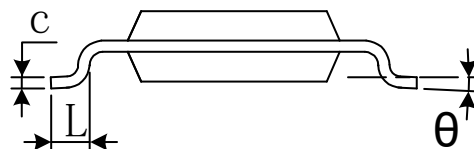
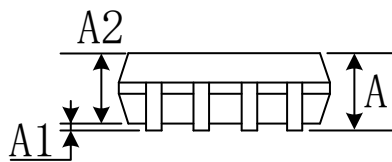


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	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
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c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

MSOP-8

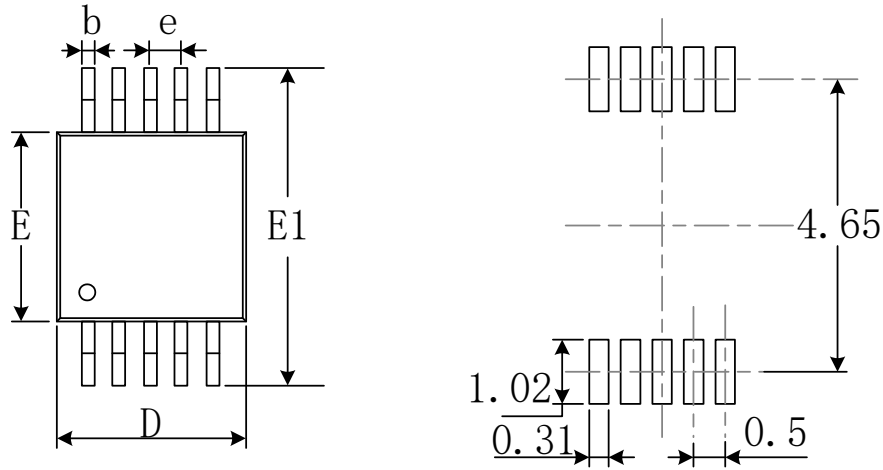


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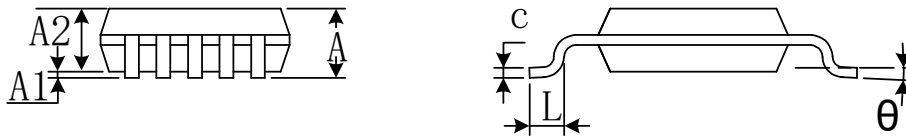


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

MSOP-10

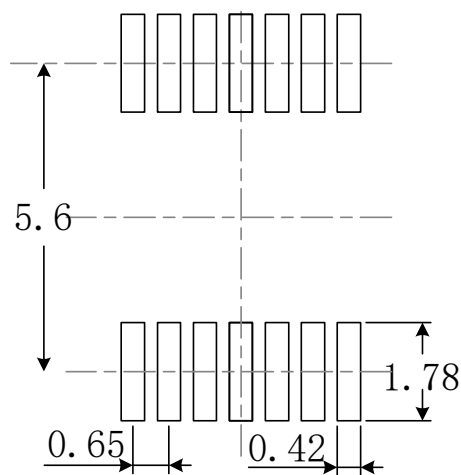
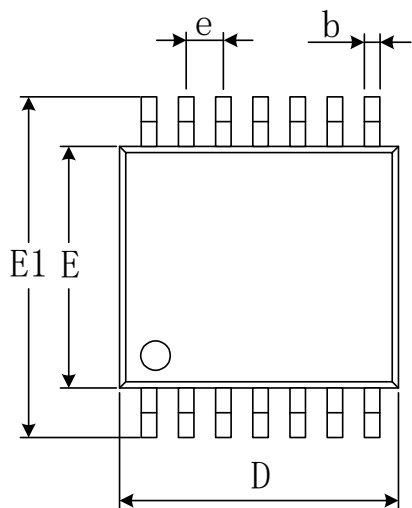


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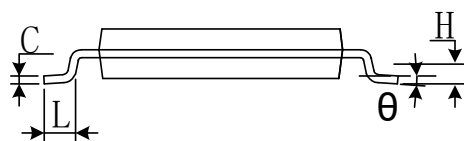
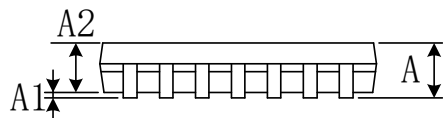


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.180	0.280	0.007	0.011
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.50(BSC)		0.020(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TSSOP-14

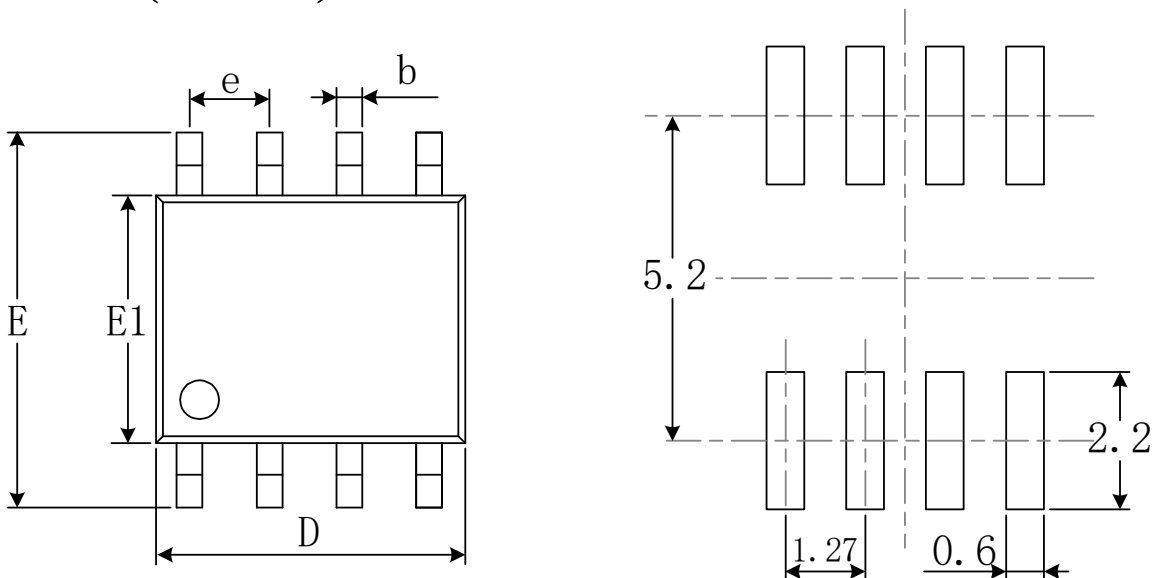


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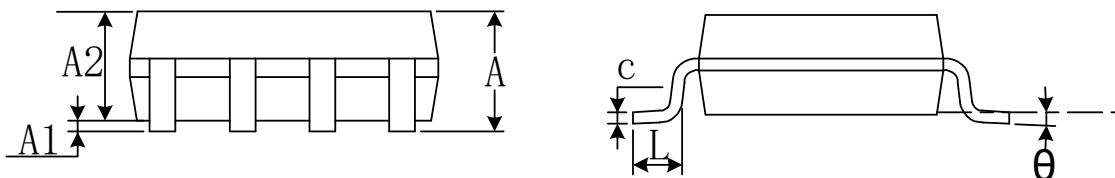


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

SOIC-8(SOP8)

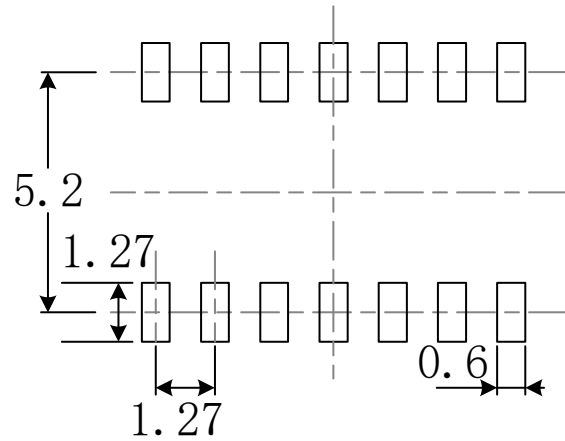
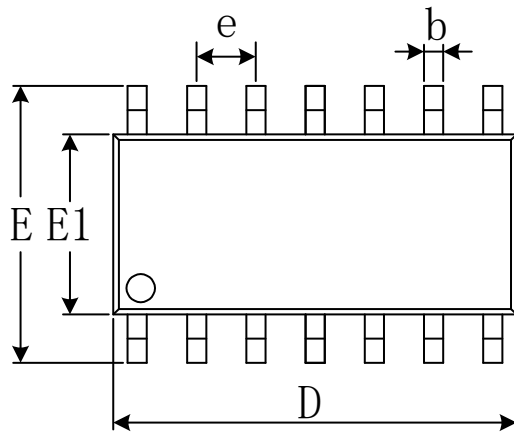


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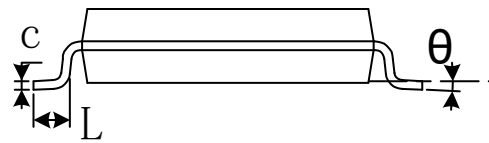
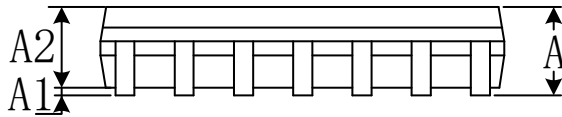


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOIC-14(SOP14)



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°